# 2SK3042

# Silicon N-Channel Power F-MOS FET

#### ■ Features

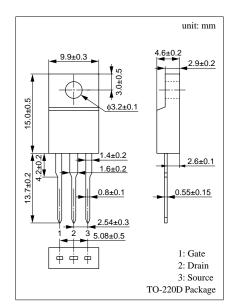
- Avalanche energy capacity guaranteed: EAS > 45mJ
- $\bullet$  High-speed switching:  $t_f = 30$ ns
- No secondary breakdown

### ■ Applications

- Contactless relay
- Diving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

## ■ Absolute Maximum Ratings (T<sub>C</sub> = 25°C)

Parameter		Symbol	Ratings	Unit	
Drain to Source breakdown voltage		V <sub>DSS</sub>	250	V	
Gate to Source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC	$I_D$	±7	A	
	Pulse	$I_{\mathrm{DP}}$	±14	A	
Avalanche energy capacity		EAS*	45	mJ	
Allowable power	$T_C = 25^{\circ}C$	D	35	W	
dissipation	Ta = 25°C	$P_{\rm D}$	2		
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature		T <sub>stg</sub>	-55 to +150	°C	

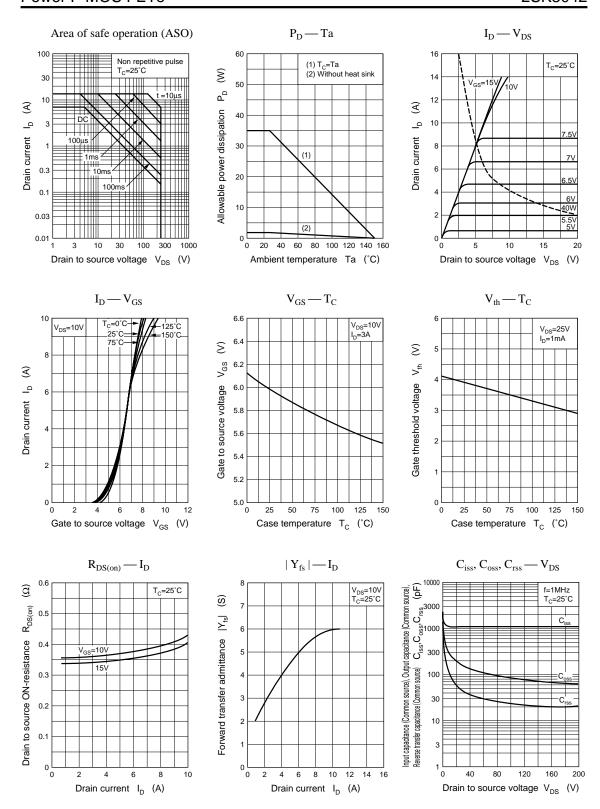


## ■ Electrical Characteristics (T<sub>C</sub> = 25°C)

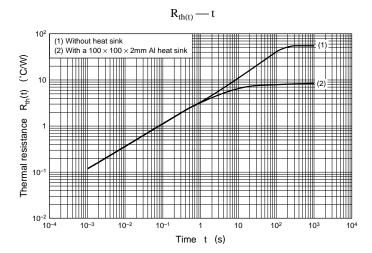
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	$I_{DSS}$	$V_{DS} = 200V, V_{GS} = 0$			0.1	mA
Gate to Source leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0$			±1	μΑ
Drain to Source breakdown voltage	V <sub>DSS</sub>	$I_D = 1 \text{mA}, V_{GS} = 0$	250			V
Gate threshold voltage	V <sub>th</sub>	$V_{DS} = 10V, I_D = 1mA$	1		5	V
Drain to Source ON-resistance	R <sub>DS(on)</sub>	$V_{GS} = 10V, I_D = 5A$		0.4	0.6	Ω
Forward transfer admittance	Y <sub>fs</sub>	$V_{DS} = 10V, I_D = 5A$	2.7	4.7		S
Diode forward voltage	V <sub>DSF</sub>	$I_{DR} = 8A, V_{GS} = 0$			-1.7	V
Input capacitance (Common Source)	C <sub>iss</sub>			1100		pF
Output capacitance (Common Source)	Coss	$V_{DS} = 10V, V_{GS} = 0, f = 1MHz$		200		pF
Reverse transfer capacitance (Common Source)	C <sub>rss</sub>			60		pF
Turn-on time (delay time)	t <sub>d(on)</sub>			20		ns
Rise time	t <sub>r</sub>	$V_{GS} = 10V, I_D = 5A$		20		ns
Turn-off time (delay time)	$t_{d(off)}$	$V_{DD} = 100V, R_L = 20\Omega$		130		ns
Fall time	$t_{\rm f}$			30		ns

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<sup>\*</sup>  $L = 0.1 \text{mH}, I_L = 8 \text{A}, V_{DD} = 50 \text{V}, 1 \text{ pulse}$ 



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